## IN THE CLAIMS:

Please amend the claims as follows. No new matter is introduced.

1. (Currently Amended) A compound comprising an epoxy group and a chalcone group represented by the following formula:

wherein n is an integer from 1 to 10,000, and each of  $R_1$ ,  $R_2$ ,  $R_3$ ,  $R_4$ ,  $R_5$ ,  $R_6$ ,  $R_7$  and  $R_8$  is selected from a group consisting of a hydrogen atom, an alkyl group, an alkoxy group, a halogen atom and a nitro group, wherein at least one of  $R_1$ ,  $R_2$ ,  $R_3$ ,  $R_4$ ,  $R_5$ ,  $R_6$ ,  $R_7$ , and  $R_8$  is the halogen and at least one of  $R_1$ ,  $R_2$ ,  $R_3$ ,  $R_4$ ,  $R_5$ ,  $R_6$ ,  $R_7$ , and  $R_8$  is the alkoxy group.

- 2. (Original) The compound according to claim 1, wherein the compound has a weight average molecular weight of about 800 to about 20,000.
- 3. (Currently Amended) A process for preparing a compound including an epoxy group and a chalcone group comprising:

reacting bis(4-4'-hydroxy) chalcone with epichorohydrin epichlorohydrin in the presence of an alkali metal salt to synthesize a compound represented by the following formula:

wherein n is an integer from 1 to 10,000, and each of  $R_1$ ,  $R_2$ ,  $R_3$ ,  $R_4$ ,  $R_5$ ,  $R_6$ ,  $R_7$  and  $R_8$  is selected from a group consisting of a hydrogen atom, an alkyl group, an alkoxy group, a halogen atom and a nitro group, wherein at least one of  $R_1$ ,  $R_2$ ,  $R_3$ ,  $R_4$ ,  $R_5$ ,  $R_6$ ,  $R_7$ , and  $R_8$  is the halogen and at least one of  $R_1$ ,  $R_2$ ,  $R_3$ ,  $R_4$ ,  $R_5$ ,  $R_6$ ,  $R_7$ , and  $R_8$  is the alkoxy group.

- 4. (Original) The process of claim 3 further comprising reacting bis[4,4'-(2-2'-tetrahydro-2H-pyranoxy)]chalcone with a paratoluene sulfonic acid in the presence of an alcohol to synthesize the bis(4-4'-hydroxy) chalcone.
- 5. (Currently Amended) The process of claim 4 further comprising reacting 4-(2-tetrahydro-2H-pyranoxy) acetohenone acetophenone with 4-(2-tetrahydro-2H-pyranoxy) benzaldehyde in the presence of an alkali metal salt to synthesize the bis[4,4'-(2-2'-tetrahydro-2H-pyranoxy)]chalcone.
- 6. (Original) The process of claim 5 further comprising reacting 4-hydroxy benzaldehyde with 3,4 dihydro-2H-pyran to synthesize the 4-(2-tetrahydro-2H-pyranoxy) benzaldehyde.
- 7. (Original) The process of claim 5 further comprising reacting 4-hydroxy acetophenone with 3,4 dihydro-2H-pyran to synthesize the 4-(2-tetrahydro-2H-pyranoxy) acetohenone.
- 8. (Original) The process of claim 3, wherein the compound has a weight average molecular weight of about 800 to about 20,000.
- 9. (Currently Amended) The process of claim <u>4</u> 3, wherein the alcohol is ethanol.
- 10. (Original) The process of claim 3, wherein the alkali metal salt is sodium hydroxide or potassium hydroxide.

- ·11. (Currently Amended) A resist composition comprising:
- (a) a compound comprising an epoxy group and a chalcone group represented by the following formula:

wherein n is an integer from 1 to 10,000 and each of  $R_1$ ,  $R_2$ ,  $R_3$ ,  $R_4$ ,  $R_5$ ,  $R_6$ ,  $R_7$  and  $R_8$  is selected from a group consisting of a hydrogen atom, <u>an</u> alkyl group, <u>an</u> alkoxy group, <u>a</u> halogen atom and <u>a</u> nitro group;

- (b) an acrylate resin;
- (b c) a curing agent; and
- (e d) an organic solvent.
- 12. (Original) The resist composition of claim 11, wherein the resist composition includes about 5 to about 35 parts by weight of the compound, about 0.01 to about 5 parts by weight of the curing agent, and about 60 to about 90 by weight of the organic solvent.
- 13. (Original) The resist composition of claim 11, wherein the organic solvent is propylene glycol monomethyl ether acetate, ethyl ethoxy acetate, or cyclohexanone.

## 14. (Canceled)

15. (Currently Amended) The resist composition of claim 11 14, wherein the resist composition includes about 5 to about 35 parts by weight of a combination of the acrylate resin and the compound, about 0.01 to about 5 parts by weight of the curing agent, and about 60 to about 90 by weight of the organic solvent.

- 16. (Currently Amended) The resist composition of claim 11, further comprising a pigment, wherein the pigment is dissolved in a solvent.
- 17. (Currently Amended) The resist composition of claim 16, further comprising a dispersant for dispersing the pigment in the photoresist composition.
- 18. (Currently Amended) The resist composition of claim 11, further comprising a photo-initiator.
- 19. (Original) The resist composition of claim 18, wherein the photo-initiator is benzl dimethyl ketal, diphenyl(2,4,6-trimethylbenzoyl)phosphine oxide, or bis(trichloromethly)-s-triazine derivative.
  - 20. (Canceled)
- 21. (Original) mThe resist composition according to claim 11, wherein the compound has a weight average molecular weight of about 800 to about 20,000.
- 22. (Original) The resist composition according to claim 16, wherein the pigment is a red, blue, green, yellow, or violet pigment.
- 23. (Original) The resist composition according to claim 11, wherein the curing agent is a dipentaerithritol hexaacrylate or a trimethylolpropane trimethacrylate.